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Image

1762

PATENT

Atty. Dkt. No. AMAT/6218/DSM/LOW K/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Lang, et al.

Serial No.: 10/092,203

Confirmation No.: 8611

Filed: March 4, 2002

For: Method of Depositing a Low Dielectric Barrier Film for Copper Damascene Application

Group Art Unit: 1762

Examiner: Lynne A. Gurley

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING
37 CFR 1.8
I hereby certify that this correspondence is being deposited on 2/17, 2004 with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

2/17/04 Kurt M. Tarbet
Date Signature

Dear Sir:

RESPONSE TO RESTRICTION REQUIREMENT DATED JANUARY 30, 2004

In response to the Restriction Requirement dated January 30, 2004, having a shortened statutory period for response set to expire on February 29, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6218/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Specification begin on page 2 of this paper. **Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper. **Remarks** begin on page 6 of this paper.